

In the Abstract:

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ABSTRACT OF THE DISCLOSURE

The circuit device has a contact element, which electrically connects a wave guide (1) with a conductor strip (2) ~~by means of two contacting areas~~. To avoid mechanical stresses due to thermal expansion the contact element is a pre-stressed formed as a precisely prefabricated leaf coil spring having reproducible properties, which is bonded connected at one contacting area of the ~~contacting areas to the wave guide (1) or the conductor strip (2) by means of an~~ electrically conducting adhesive or glue, while a sliding contact is provided on the conductor strip (2) or the wave guide (1) at the other contacting area the second ~~contacting area is provided as a sliding contact, whereby the coil spring is pre-~~ stressed. The prefabricated leaf spring is preferably a MIGA leaf spring precisely made by UV depth lithography and multilayer galvanic methods in a batch production process.